|  |  | Searc   | h By: <sup>IN</sup> Part Number   | <u>Sign</u><br>م Text   |
|--|--|---|---|---|
| Electronics  |  |   | r a complete or partial part nur  |   |
| Products Documentation   |  | omer Support About  |   |   |
| Home > Products > By Type > Par  | rallel (Stacking) Configuration > Produc   | t Feature Selector > Pr   | oduct Details   |   |
| Product Details for 1  | - 120521 - 2   |   |   |   |
|  | .4mm, .5mm, .6mm, .8r  |   |   | Quick Links   |
| THE REPORT OF THE OWNER.   | Pitch, Surface Mount,  | Stacking Bd   | -to-Bd  | Check Pricing &   |
| TRANSPORT OF THE OWNER OWNER OF THE OWNER | Connectors   |   |   | Availability<br>Search for Tooling  |
| France and and and and   | 5 of 6 RoHS/ELV Complian<br>Alternates/Compliance Stateme  |   | <u>pliant</u>   | View Mating   |
| 1-120521 -2  |  | ,   |   | Products (18)<br>Product Feature  |
| 1-120521 -2  | Product Highlights:  |   |   | Selector<br>Contact Us About  |
| Ant  | <ul> <li>? Receptacle</li> <li>? Family Name = Free He</li> </ul>  | eight   |   | This Product  |
| Active   | ? 1.00 mm Centerline   | 0   |   |   |
|  | <ul> <li>Number of Positions = 84</li> <li>In -Line Contact Layout</li> </ul>  |   |   |   |
|  | View all Features  |   |   |   |
|  |  |   |   |   |
| Documentation & Addition   | onal Information   |   |   |   |
| Product Drawings:  |  |   | Additional Ir   | formation:  |
| ? RECEPTACLE ASS   | Y, 1.0mm FH(IEEE1386) CONN   | NECTOR (PDF,  | ? Produc  | t Line Information  |
| English)   |  |   | Additional P  | roduct Images:  |
| Catalog Pages/Data Shee  | ets:   |   | ? Produc  |   |
| ? None Available   |  |   |   |   |
| Product Specifications:  |  |   | Related Proc  |   |
| ? None Available   |  |   |   | Products (18)   |
|  |  |   | _   |   |
| Application Specification<br>? None Available  | IS:  |   |   |   |
|  |  |   |   |   |
| Instruction Sheets:  |  |   |   |   |
| ? None Available   |  |   |   |   |
|  |  |   |   |   |
|  | & Compression Information  | )   |   |   |
| ? <u>3D Model</u> (STEP, V   | /ersion H)   | )   |   |   |
| <ul> <li><u>3D Model</u> (STEP, V</li> <li><u>3D Model</u> (IGES, V</li> </ul>   | /ersion H)<br>ersion H)  | )   |   |   |
| ? <u>3D Model</u> (STEP, V   | /ersion H)<br>ersion H)  | )   |   |   |
| <ul> <li><u>3D Model</u> (STEP, V</li> <li><u>3D Model</u> (IGES, V</li> </ul>   | /ersion H)<br>ersion H)  | )<br>List all Document  | <u>s</u>  |   |
| <ul> <li><u>3D Model</u> (STEP, V</li> <li><u>3D Model</u> (IGES, V</li> <li><u>2D Drawing</u> (DXF,</li> </ul>  | /ersion H)<br>ersion H)  |   | <u>s</u>  |   |
| <ul> <li><u>3D Model</u> (STEP, V</li> <li><u>3D Model</u> (IGES, V</li> <li><u>2D Drawing</u> (DXF,</li> </ul> Product Features (Please Product Type Features:  | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit  | y)<br>Housing Rela  | ated Features:  |   |
| <ul> <li><u>3D Model</u> (STEP, V</li> <li><u>3D Model</u> (IGES, V</li> <li><u>2D Drawing</u> (DXF,</li> </ul> Product Features (Please<br>Product Type Features:<br><u>Product Type</u> = Re   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle  | y)<br>Housing Rela<br>? Housing   | ated Features:<br>g Color = Black   |   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Features (Please<br>Product Type Features:<br><ul> <li>Product Type = Re</li> <li>Number of Positions</li> </ul>  | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84  | y)<br>Housing Rela<br>? Housing<br>? Housing<br>? Housing   | a <b>ted Features:</b><br>g Color = Black<br>g Material = High T  | emperature  |
| <ul> <li><u>3D Model</u> (STEP, V</li> <li><u>3D Model</u> (IGES, V</li> <li><u>2D Drawing</u> (DXF,</li> </ul> Product Features (Please<br>Product Type Features:<br><u>Product Type</u> = Re   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84  | y)<br>Housing Rela<br>? Housing<br>? Housing<br>Thermo<br>? Housing   | a <b>ted Features:</b><br>g Color = Black<br>g Material = High T<br>pplastic<br>g Flammability Rati   | ng = UL 94V - 0   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Features (Please Product Type Features: <ul> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84  | y)<br>Housing Rela<br>? Housing<br>? Housing<br>Thermo<br>? Housing   | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic  | ng = UL 94V - 0   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Features (Please Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul>  | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical  | y)<br>Housing Rela<br>? Housing<br>? Housing<br>Thermo<br>? Housing<br>? Housing  | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera   | ng = UL 94V - 0   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Features (Please Product Type Features: <ul> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>86 Mezzanine Connector.   | y)<br>Housing Rela<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>Industry Star<br>? RoHS/E   | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance  | ng = UL 94V - 0   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Features (Please Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to - Board State</li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00  | y)<br>Housing Rela<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? RoHS/E<br>Complia   | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant   | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> </li> <li>Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to - Board State [0.315], 9.00 [0.354],</li> </ul> </li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>, 10.00 [0.394]   | y)<br>Housing Rela<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? RoHS/E<br>Complia<br>? Lead Fi  | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process   | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (IDXF,</li> </ul> Product Features (Please Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to -Board State [0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> </ul>  | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>#86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>, 10.00 [0.394]<br>Vith  | y)<br>Housing Rela<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? RoHS/E<br>Compli<br>? Lead Fi<br>capable<br>C, Way   | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>e to 240°C, Wave s<br>re solder capable to   | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>o 265°C, Reflow   |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> </li> <li>Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to - Board State [0.315], 9.00 [0.354],</li> </ul> </li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>euse the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>, 10.00 [0.394]<br>Vith<br>/ithout                                     | y)<br>Housing Rela<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Lead Fl<br>capable<br>C, Way<br>solder of  | ated Features:<br>g Color = Black<br>g Material = High T<br>pplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>e solder capable to<br>capable to 245°C, F   | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>0 265°C, Reflow<br>Reflow solder capable                          |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to -Board State [0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> <li>Vacuum Cover = W</li> <li>Number of Rows = D</li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>e use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>#86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>, 10.00 [0.394]<br>Vith<br>/ithout<br>Dual                           | y)<br>Housing Rela<br>? Housing<br>Thermo<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Industry Star<br>? RoHS/E<br>Complia<br>? Lead Fl<br>capable<br>C, Wav<br>solder o<br>to 260°  | ated Features:<br>g Color = Black<br>g Material = High T<br>pplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>e solder capable to<br>capable to 245°C, F   | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>0 265°C, Reflow<br>Reflow solder capable<br>capable to 245°C, Pin |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to -Board State [0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> <li>Vacuum Cover = W</li> <li>Number of Rows = D</li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>a use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>, 10.00 [0.394]<br>Vith<br>/ithout<br>Dual<br>S:                      | y)<br>Housing Rela<br>? Housing<br>Thermo<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? RoHS/E<br>Complia<br>? Lead Fl<br>capable<br>C, Wav<br>solder o<br>to 260°<br>in - Past   | ated Features:<br>g Color = Black<br>g Material = High T<br>pplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>e solder capable to<br>capable to 245°C, F<br>C, Pin - in-Paste<br>te capable to 260°C                                       | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>0 265°C, Reflow<br>Reflow solder capable<br>capable to 245°C, Pin |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> </li> <li>Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to - Board State [0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> <li>Vacuum Cover = W</li> <li>Number of Rows = D</li> </ul> </li> <li>Contact Related Features: <ul> <li>Family Name = Free</li> </ul> </li> </ul>  | /ersion H)<br>ersion H)<br>Version H)<br>= use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>:86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>(0.00 [0.394]<br>Vith<br>/ithout<br>Dual<br>S:<br>Height             | y)<br>Housing Rela<br>? Housing<br>Thermo<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Lead Fi<br>Capable<br>C, Way<br>solder C<br>to 260°<br>in - Past   | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>re solder capable to 245°C, F<br>C, Pin -in-Paste<br>te capable to 260°C<br>elated Features:                                 | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>o 265°C, Reflow<br>Reflow solder capable<br>capable to 245°C, Pin |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> </ul> Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to -Board State [0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> <li>Vacuum Cover = W</li> <li>Number of Rows = D</li> </ul>   | /ersion H)<br>ersion H)<br>Version H)<br>= use the Product Drawing for all design activit<br>ceptacle<br>= 84<br>Vertical<br>:86 Mezzanine Connector.<br>= 1.00 [0.039]<br>ack Height (mm [in]) = 8.00<br>(0.00 [0.394]<br>Vith<br>/ithout<br>Dual<br>S:<br>Height<br>In -Line | y)<br>Housing Rela<br>? Housing<br>Thermo<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Housing<br>? Lead Fi<br>Capable<br>C, Way<br>solder C<br>to 260°<br>in - Past   | ated Features:<br>g Color = Black<br>g Material = High T<br>pplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>e solder capable to<br>capable to 245°C, F<br>C, Pin - in-Paste<br>te capable to 260°C                                       | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>o 265°C, Reflow<br>Reflow solder capable<br>capable to 245°C, Pin |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> </li> <li>Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to - Board State [0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> <li>Vacuum Cover = W</li> <li>Number of Rows = D</li> </ul> </li> <li>Contact Related Features: <ul> <li>Family Name = Free</li> <li>Contact Material = C</li> <li>Contact Mating Area</li> </ul> </li> </ul>   | <pre>/ersion H) ersion H) Version H)  e use the Product Drawing for all design activit ceptacle = 84 Vertical 86 Mezzanine Connector = 1.00 [0.039] ack Height (mm [in]) = 8.00 10.00 [0.394] Vith /ithout Dual S: Height In -Line copper Alloy Plating = Gold (50)</pre>      | Housing Relation in the second sec | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>e solder capable to<br>capable to 245°C, F<br>C, Pin -in-Paste<br>te capable to 260°C<br>elated Features:<br>ing Method = Ta | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>o 265°C, Reflow<br>Reflow solder capable<br>capable to 245°C, Pin |
| <ul> <li>3D Model (STEP, V</li> <li>3D Model (IGES, V</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>2D Drawing (DXF,</li> <li>Product Type Features: <ul> <li>Product Type Features:</li> <li>Product Type = Re</li> <li>Number of Positions</li> <li>PCB Mount Angle =</li> <li>Keyed = No</li> <li>Comment = IEEE 13</li> </ul> </li> <li>Body Related Features: <ul> <li>Centerline (mm [in])</li> <li>Board -to - Board Star<br/>[0.315], 9.00 [0.354],</li> <li>Locating Posts = V</li> <li>Vacuum Cover = W</li> <li>Number of Rows = D</li> </ul> </li> <li>Contact Related Features: <ul> <li>Family Name = Free</li> <li>Contact Layout = I</li> <li>Contact Material = C</li> </ul> </li> </ul>   | <pre>/ersion H) ersion H) Version H)  e use the Product Drawing for all design activit ceptacle = 84 Vertical 86 Mezzanine Connector = 1.00 [0.039] ack Height (mm [in]) = 8.00 10.00 [0.394] Vith /ithout Dual S: Height In -Line copper Alloy Plating = Gold (50)</pre>      | Housing Relation in the second sec | ated Features:<br>g Color = Black<br>g Material = High T<br>oplastic<br>g Flammability Rati<br>g Material Tempera<br>ndards:<br>ELV Compliance<br>ant<br>ree Solder Process<br>a to 240°C, Wave s<br>e solder capable to<br>capable to 245°C, F<br>C, Pin -in-Paste<br>te capable to 260°C<br>elated Features:<br>ing Method = Ta | ng = UL 94V -0<br>ature = High<br>= ELV compliant, 5 of 6<br>es = Wave solder<br>older capable to 260°<br>o 265°C, Reflow<br>Reflow solder capable<br>capable to 245°C, Pin |

 Languages
 : English
 Deutsch
 Español
 Português (do Brasil)
 ???????
 Italiano
 ????
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ????
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ???
 ????
 ???
 ????
 <t